



<p>[1-1] PCB 1.6 mm thick, 2x 2.55 dia thru holes DUMMY-CHIP 25mm SQ 3.5 mm thick HEATSINK UBM50-25B(φ2.8) Base 3.5mm 49.2g Push-pin PIP2.5x18 SPRING S001YJ2T TIM YG6260 TOTAL FORCE 5.05 kgf (49.53N) 11.5PSI</p>	<p>[2-1] 2 [2-2] PCB 1.6 mm thick, 2x 2.5 dia thru holes DUMMY-CHIP 25mm SQ 3.5 mm thick HEATSINK UBM50-25B(φ2.8) Base 3.5mm 49.2g Push-pin PIP2.5x18 SPRING S001YJ2T TIM YG6260 TOTAL FORCE 5.05 kgf (49.53N) 11.5PSI</p>	<p>[3-1] 3 [3-2] PCB 1.6 mm thick, 2x 2.45 dia thru holes DUMMY-CHIP 25mm SQ 3.5 mm thick HEATSINK UBM50-25B(φ2.8) Base 3.5mm 49.2g Push-pin PIP2.5x18 SPRING S001YJ2T TIM YG6260 TOTAL FORCE 5.05 kgf (49.53N) 11.5PSI</p>
<p>[1-2] PCB 1.6 mm thick, 2x 2.55 dia thru holes DUMMY-CHIP 25mm SQ 4.0 mm thick HEATSINK UBM50-25B(φ2.8) Base 3.0mm 37.3g Push-pin PIP2.5x18 SPRING S001YJ2T TIM YG6260 TOTAL FORCE 5.05 kgf (49.53N) 11.5PSI</p>	<p>[2-2] PCB 1.6 mm thick, 2x 2.5 dia thru holes DUMMY-CHIP 25mm SQ 4.0 mm thick HEATSINK UBM50-25B(φ2.8) Base 3.0mm 37.3g Push-pin PIP2.5x18 SPRING S001YJ2T TIM YG6260 TOTAL FORCE 5.05 kgf (49.53N) 11.5PSI</p>	<p>[3-2] PCB 1.6 mm thick, 2x 2.45 dia thru holes DUMMY-CHIP 25mm SQ 4.0 mm thick HEATSINK UBM50-25B(φ2.8) Base 3.0mm 37.3g Push-pin PIP2.5x18 SPRING S001YJ2T TIM YG6260 TOTAL FORCE 5.05 kgf (49.53N) 11.5PSI</p>
<p>[4-1] 4 [4-2] PCB 1.6 mm thick, 2x 2.5 dia thru holes DUMMY-CHIP 25mm SQ 4.0 mm thick HEATSINK UBR45-25B(φ2.8) Base3.0mm 40.1g Push-pin PIP2.5x18 SPRING S001YJ2T TIM YG6260 TOTAL FORCE 5.05 kgf (49.53N) 11.5PSI</p>	<p>[5] 5 PCB 1.6 mm thick, 2x 2.5 dia thru holes DUMMY-CHIP 25mm SQ 3.0 mm thick HEATSINK UBM70-25B(φ2.8) Base4.0mm 106.4g Push-pin PIP2.5x18 SPRING S001YJ2T TIM YG6260 TOTAL FORCE 5.05 kgf (49.53N) 11.5PSI</p>	<p>[6] 6 PCB 1.6 mm thick, 4x 1.8 dia thru holes DUMMY-CHIP 25.0mm SQ 3.0mm thick HEATSINK UB90-14.6(QT) Base 5.6mm 160g Anchor Pin ANCR-16 Torsion spring S001YZ4M (wire 1.0 dia) TIM YG6260 TOTAL FORCE 8.4 kgf (82.4N) 19.1PSI</p>
<p>[4-2] PCB 1.6 mm thick, 2x 2.5 dia thru holes DUMMY-CHIP 25mm SQ 4.0 mm thick HEATSINK UBM40-25B(φ2.8) Base 3.0mm 29.2g Push-pin PIP2.5x18 SPRING S001YJ2T TIM YG6260 TOTAL FORCE 5.05 kgf (49.53N) 11.5PSI</p>		
<p>[7] 7 PCB 1.6 mm thick, 2x 1.8 dia thru holes DUMMY-CHIP 25.0mm SQ 1.7mm thick HEATSINK QTUH60-25B Base 2.5 mm 64.3g Anchor Pin ANCR-12 Torsion spring S001YZ4M (wire 1.0 dia) TIM YG6260 TOTAL FORCE 4.2 kgf (41.2N) 9.5PSI</p>	<p>[8] 8 PCB 1.6 mm thick, 2x 1.8 dia thru holes DUMMY-CHIP 25.0mm SQ 3.0mm thick HEATSINK UB70-18B(QT) Base 3.0mm 81g Anchor Pin ANCR-13 Torsion spring S001YZ4M (wire 1.0 dia) TIM YG6260 TOTAL FORCE 4.2 kgf (41.2N) 9.5PSI</p>	<p>[9] 9 PCB 1.6 mm thick, 4x 1.8 dia thru holes DUMMY-CHIP 25.0mm SQ 3.0mm thick HEATSINK UB80-25B(QT) Base5.6 mm 160g Anchor Pin ANCR-16 Torsion spring S001YZ4M (wire 1.0 dia) TIM YG6260 TOTAL FORCE 8.4 kgf (82.4N) 19.1PSI</p>